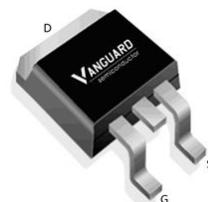


## Features

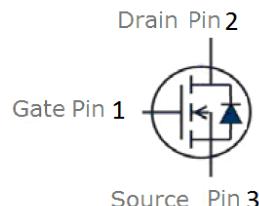
- N-Channel, 5V Logic Level Control
- Enhancement mode
- Low on-resistance  $R_{DS(on)}$  @  $V_{GS}=4.5$  V
- VitoMOS® Technology
- 100% Avalanche Tested
- Pb-free lead plating; RoHS compliant

$V_{DS}$	80	V
$R_{DS(on),TYP}$ @ $V_{GS}=10$ V	8	mΩ
$R_{DS(on),TYP}$ @ $V_{GS}=4.5$ V	9	mΩ
$I_D$	80	A

TO-263



Part ID	Package Type	Marking	Tape and reel information
VSM007N07MS	TO-263	007N07M	1000pcs/Reel



## Maximum ratings, at $T_A=25$ °C, unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	80	V
$V_{GS}$	Gate-Source voltage	±20	V
$I_S$	Diode continuous forward current	$T_C=25^\circ\text{C}$	A
$I_D$	Continuous drain current @ $V_{GS}=10\text{V}$	$T_C=25^\circ\text{C}$	A
		$T_C=100^\circ\text{C}$	A
$I_{DM}$	Pulse drain current tested ①	$T_C=25^\circ\text{C}$	A
$I_{DSM}$	Continuous drain current @ $V_{GS}=10\text{V}$	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	A
$EAS$	Avalanche energy, single pulsed ②	197	mJ
$P_D$	Maximum power dissipation	$T_C=25^\circ\text{C}$	W
$P_{DSM}$	Maximum power dissipation ③	$T_A=25^\circ\text{C}$	W
$T_{STG}, T_J$	Storage and Junction Temperature Range	-55 to 175	°C

## Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.25	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	°C/W



## Typical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ <math>T_j = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	80	--	--	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current( $T_j=25^\circ\text{C}$ )	$V_{\text{DS}}=80\text{V}, V_{\text{GS}}=0\text{V}$	--	--	1	$\mu\text{A}$
	Zero Gate Voltage Drain Current( $T_j=125^\circ\text{C}$ )	$V_{\text{DS}}=80\text{V}, V_{\text{GS}}=0\text{V}$	--	--	100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	--	--	$\pm 100$	nA
$V_{\text{GS(TH)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1.3	--	2.3	V
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance ④	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=40\text{A}$	--	8	11	$\text{m}\Omega$
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance ④	$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=20\text{A}$	--	9	12	$\text{m}\Omega$
<b>Dynamic Electrical Characteristics @ <math>T_j = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	3500	4420	5300	pF
$C_{\text{oss}}$	Output Capacitance		100	225	350	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		90	195	300	pF
$R_g$	Gate Resistance	$f=1\text{MHz}$	--	3.4	--	$\Omega$
$Q_g$	Total Gate Charge	$V_{\text{DS}}=40\text{V}, I_{\text{D}}=40\text{A}, V_{\text{GS}}=10\text{V}$	--	71	--	nC
$Q_{\text{gs}}$	Gate-Source Charge		--	22	--	nC
$Q_{\text{gd}}$	Gate-Drain Charge		--	24	--	nC
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=40\text{V}, I_{\text{D}}=40\text{A}, R_{\text{G}}=3\Omega, V_{\text{GS}}=10\text{V}$	--	23	--	ns
$t_r$	Turn-on Rise Time		--	17	--	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	40	--	ns
$t_f$	Turn-Off Fall Time		--	14	--	ns
<b>Source- Drain Diode Characteristics@ <math>T_j = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$V_{\text{SD}}$	Forward on voltage	$I_{\text{SD}}=40\text{A}, V_{\text{GS}}=0\text{V}$	--	0.8	1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$T_j=25^\circ\text{C}, I_{\text{SD}}=40\text{A}, V_{\text{GS}}=0\text{V}$ $dI/dt=500\text{A}/\mu\text{s}$	--	29	--	ns
$Q_{\text{rr}}$	Reverse Recovery Charge		--	131	--	nC

NOTE:

- ① Repetitive rating; pulse width limited by max junction temperature.
- ② Limited by  $T_{j\text{max}}$ , starting  $T_j = 25^\circ\text{C}$ ,  $L = 0.5\text{mH}$ ,  $R_g = 25\Omega$ ,  $I_{AS} = 22\text{A}$ ,  $V_{GS} = 10\text{V}$ . Part not recommended for use above this value
- ③ The power dissipation  $P_{DSM}$  is based on  $R_{\text{DS(on)}}$  and the maximum allowed junction temperature of  $150^\circ\text{C}$ .
- ④ Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

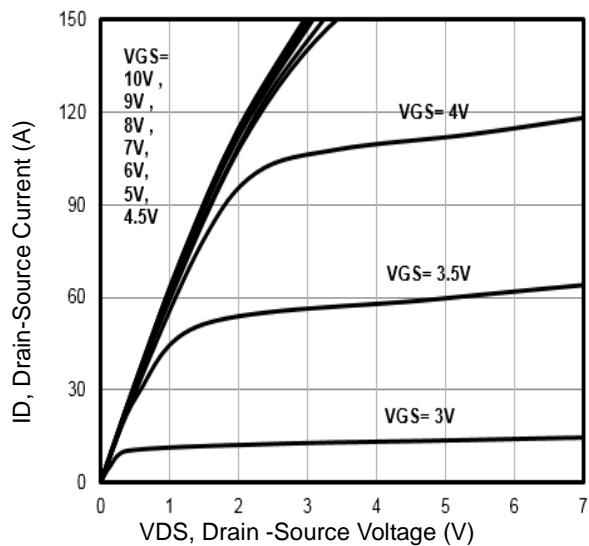


Vanguard  
Semiconductor

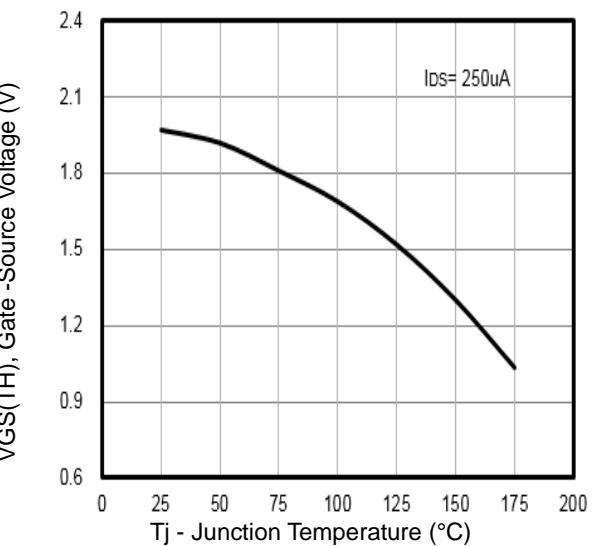
**VSM007N07MS**

**80V/80A N-Channel Advanced Power MOSFET**

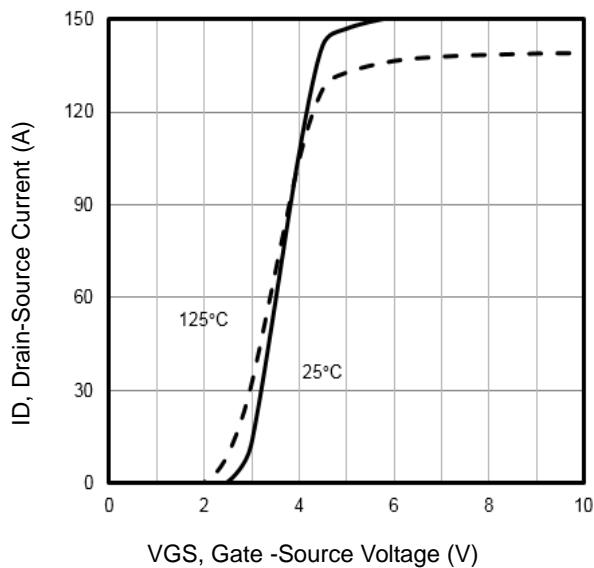
## Typical Characteristics



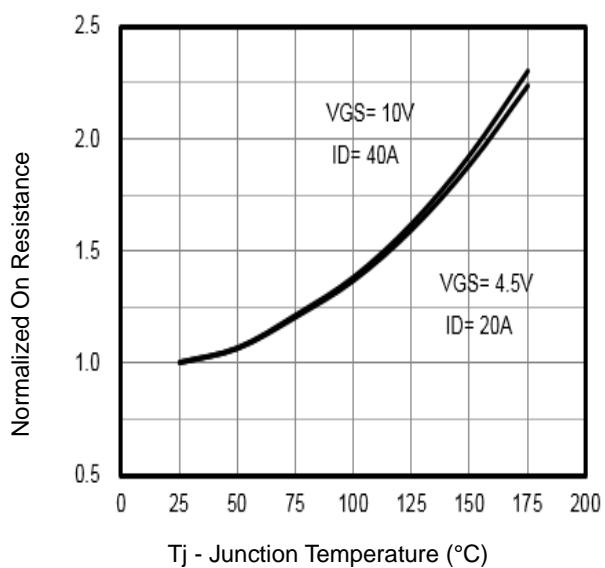
**Fig1.** Typical Output Characteristics



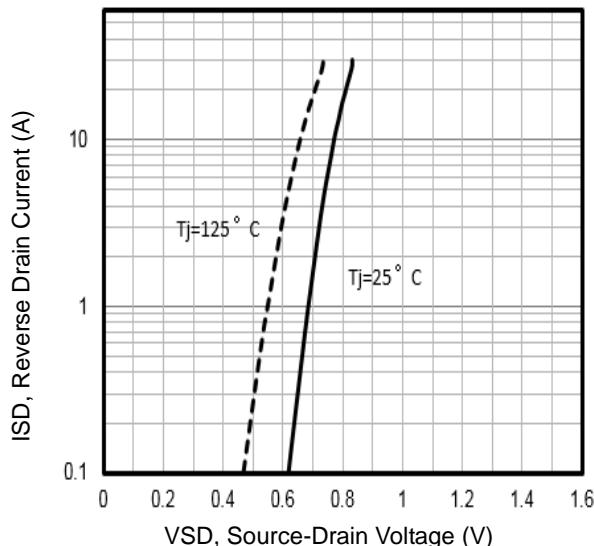
**Fig2.**  $V_{GS(TH)}$  Gate -Source Voltage Vs.  $T_j$



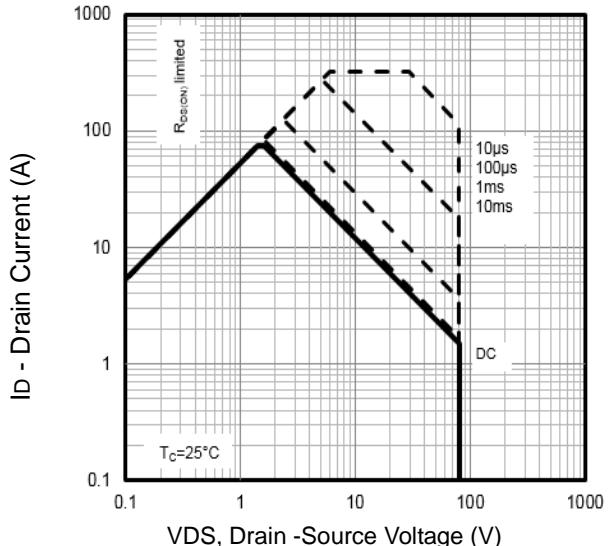
**Fig3.** Typical Transfer Characteristics



**Fig4.** Normalized On-Resistance Vs. Temperature



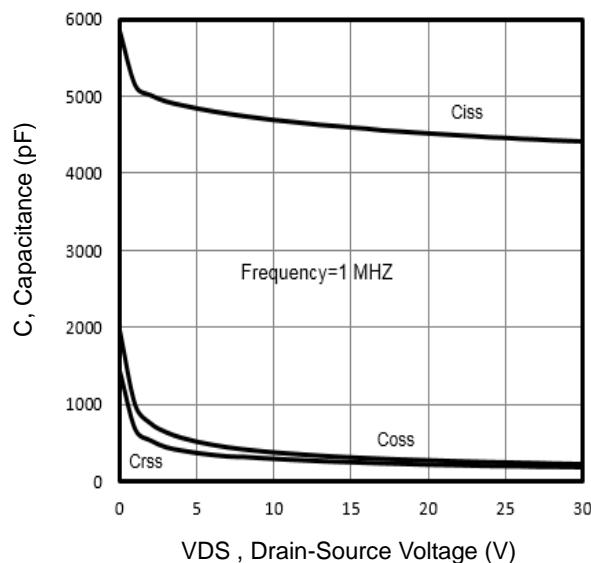
**Fig5.** Typical Source-Drain Diode Forward Voltage



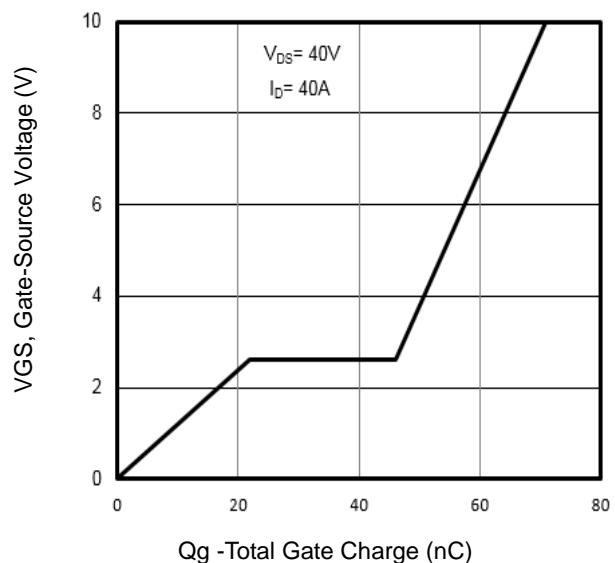
**Fig6.** Maximum Safe Operating Area



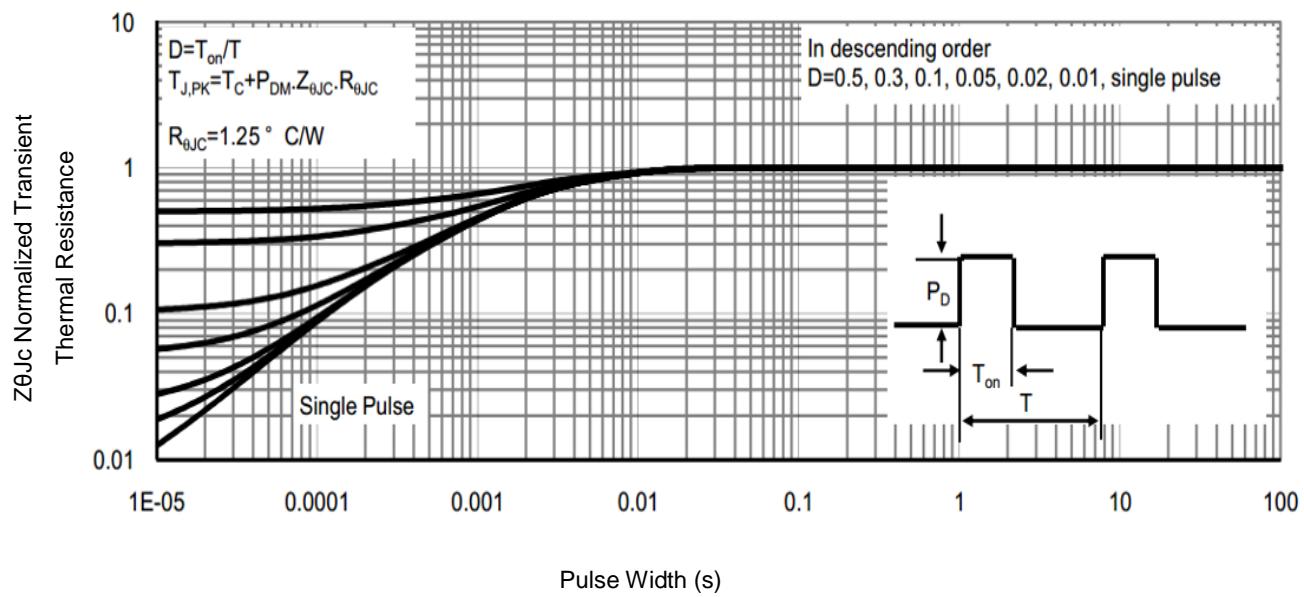
## Typical Characteristics



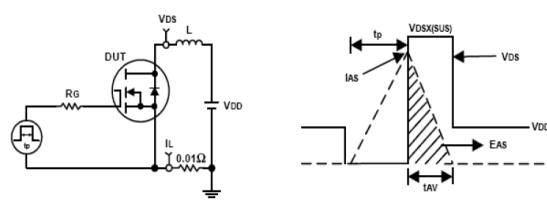
**Fig7.** Typical Capacitance Vs.Drain-Source Voltage



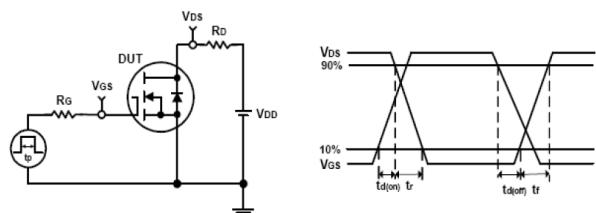
**Fig8.** Typical Gate Charge Vs.Gate-Source Voltage



**Fig9.** Normalized Maximum Transient Thermal Impedance

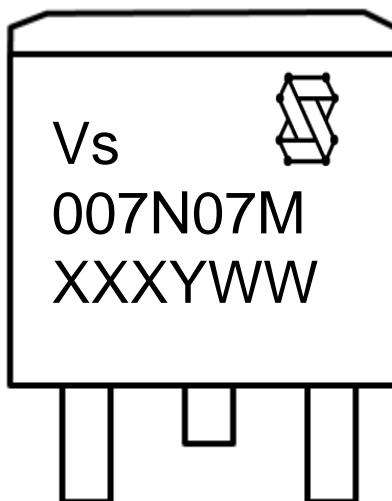


**Fig10.** Unclamped Inductive Test Circuit and waveforms



**Fig11.** Switching Time Test Circuit and waveforms

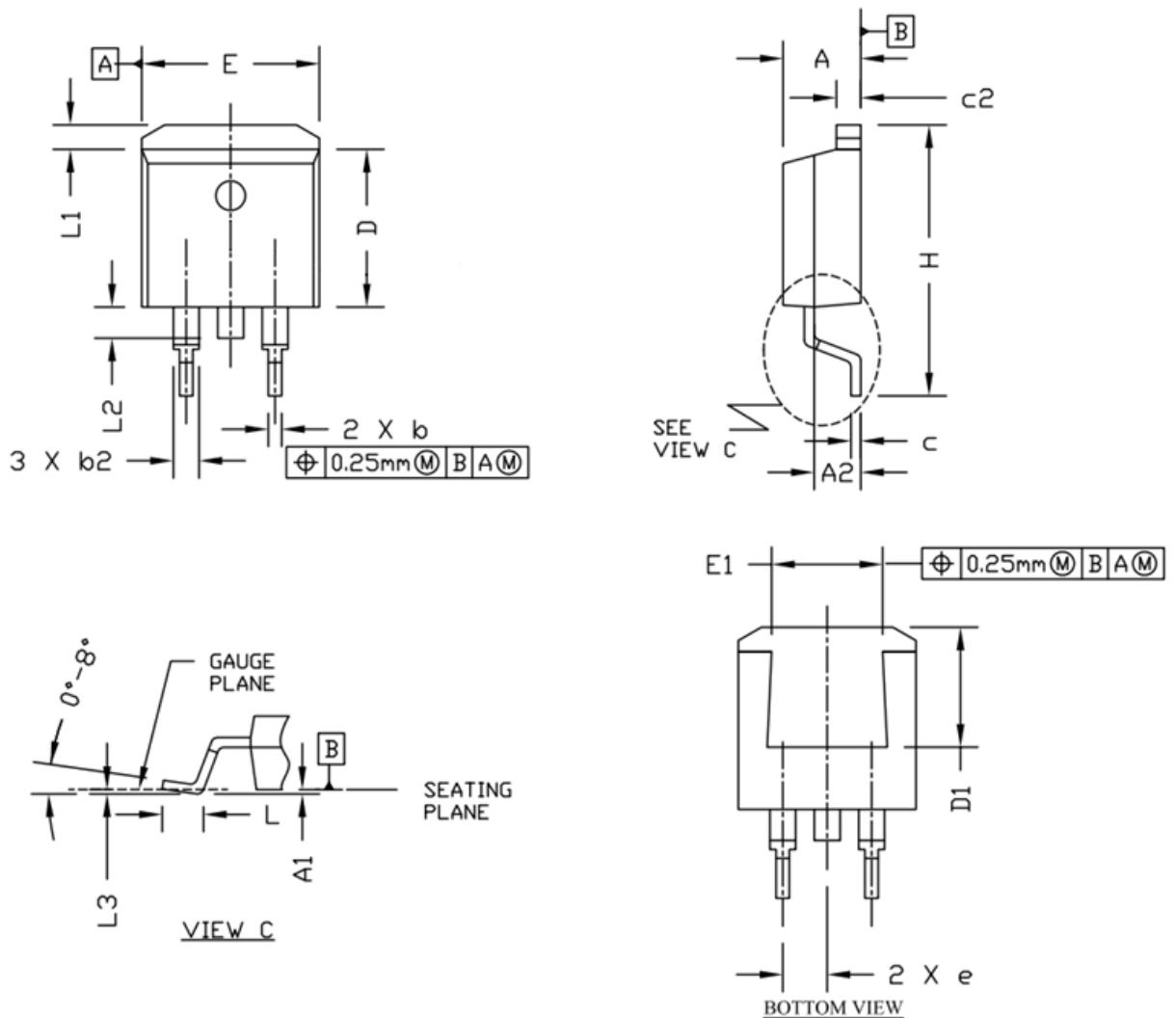
**Marking Information**



1st line: Vanguard Code (Vs), Vanguard Logo  
2nd line: Part Number (007N07M)  
3rd line: Date code (XXXYWW)  
    XXX: Wafer Lot Number  
    Y: Year Code, e.g. E means 2017  
    WW: Week Code



### TO-263 Package Outline Data



Symbol	Dimensions (unit: mm)		
	Min	Typ	Max
A	4.400	4.570	4.700
A1	0.000	0.100	0.200
A2	2.300	2.400	2.500
b	0.700	0.800	0.900
b2	1.200	1.270	1.360
c	0.381	0.500	0.737
c2	1.220	1.300	1.350
D	8.600	9.200	9.300
D1	6.860		
e	2.540 BSC		
E	9.780	9.880	10.260
E1	6.225		
H	14.700	15.100	15.500
L	2.000	2.550	2.750
L1	1.000	1.200	1.400
L2	1.300	1.600	1.700
L3	0.255 BSC		

#### Notes:

1. Refer to JEDEC TO-263 variation AB
2. Dimension "D" & "E" do NOT include mold flash, mold flash shall not exceed 0.127mm per side.

### Customer Service

#### Sales and Service:

[sales@vgsemi.com](mailto:sales@vgsemi.com)

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